



FEATURES

ESD protection f	for high speed data	lines to IEC61000-4-2
------------------	---------------------	-----------------------

ESD contact discharge typical 8KV, max 15KV

| ESD air discharge typical 15KV, max 25KV

Surface mount

| Extremely low capacitance

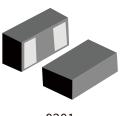
I Very low leakage current

Fast response time

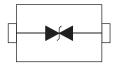
| Bi-directional ESD protection

Lead free solder termination

I The best ESD protection for high frequency, low voltage applications



0201



Schematic Symbol

APPLICATIONS

١	High Definition	Multi-Media	Interface	(HDMI))
---	-----------------	-------------	-----------	--------	---

- | Digital Visual Interface (DVI)
- | Display Port Interface (DP)
- | Unified Display Interface (UDI)
- | Mobile Display Digital Interface (MDDI)
- Gigabit Ethernet
- USB2.0 and USB3.0
- IEEE1394 interface

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

CAUTION

This component is designed for signal line protection only, Not intended to be used under bias, not for application with a power line.



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
-	Maximum Contact discharge voltage Per IEC61000-4-2	15KV	V
-	Maximum Air discharge voltage Per IEC61000-4-2	25KV	V
T _{OPER}	Maximum Operating temperature	-40 to +90	°C
T _{STG}	Maximum Storage temperature	-55 to +125	°C
T _L	Maximum lead temperature for soldering during 10s	260	°C

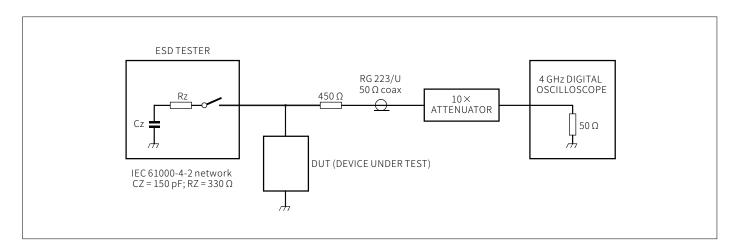
ELECTRICAL CHARACTERISTICS(T_A=25°C)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V_R	Rated Voltage	-	-	-	30	V
V _T	Trigger Voltage	IEC61000-4-28KV contact discharge	-	300	-	V
V _C	Clamping Voltage	IEC61000-4-28KV contact discharge	-	35	-	V
I	Leakage Current	DC 5V shall be applied on component	-	0.01	0.1	μΑ
C _P	Capacitance	$V_R = 0V, f = 1MHz$	-	0.05	-	pF

Note:

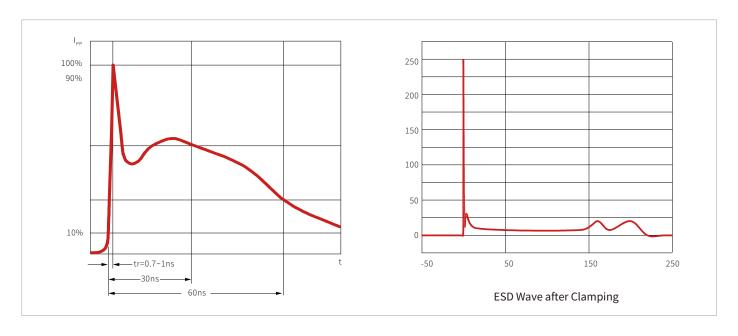
- 1, Trigger and clamping voltage are measured per IEC 61000-4-2, 8KV contact discharge method.
- 2. After reliability tests such as high temp storage, temp cycles, continuous ESD strike etc, the maximum leakage current is less than 10uA.

ESD CLAMPING TEST



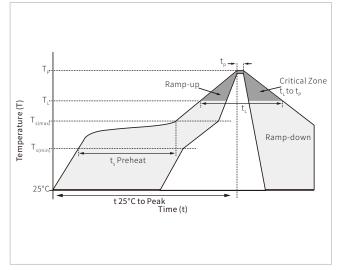


CHARACTERISTIC CURVES



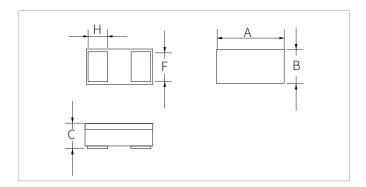
SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly	
	Temperature Max $(T_{s(min)})$	150°C	
Pre Heat	Temperature Max $(T_{s(max)})$	200°C	
	Time (min to max) (t_s)	60 – 180 secs	
Average ran	np up rate (Liquidus Temp (T_L) to peak	3°C/second max	
	$T_{S(max)}$ to T_L - Ramp-up Rate	3°C/second max	
Reflow	Temperature (T _L) (Liquidus)	217°C	
Kellow	Time (min to max) (t_L)	60 – 150 seconds	
Peak Temp	erature (T _P)	260°C	
Time within	Time within 5°C of actual peak Temperature (t _n)		
Ramp-down Rate		6°C/second max	
Time 25°C t	Time 25°C to peak Temperature (T _P)		
Do not exceed		260°C	



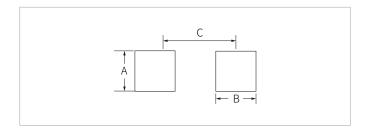


PACKAGE INFORMATION



Ref.	Dimension			n		
Kei.	Min.	Тур	Max.	Unit		
А	0.50	0.60	0.70			
В	0.25	0.30	0.35			
С	0.25	0.30	0.35	mm		
Н	0.18	0.20	0.22			
F	0.25	0.27	0.29			

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Dimension	Unit
А	0.30	
В	0.25	mm
С	0.40	

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
SAE0201B30UA	0201	10000PCS	7"



Headquarters

No.3387 Shendu Road Pujiang I&E Park Minhang Shanghai China 201000

Hotline

400-021-5756

Web

Https://www.semiware.com

Sales Center

Tel: 86-21-3463-7458 Email: sales18@semiware.com

Customer Service

Tel: 86-21-5484-1001

Email: sales17@semiware.com

Technical Support

Tel: 86-21-3463-7654

Email: fae01@semiware.com

Complaint & Suggestions

Tel: 86-21-3463-7172

Ext: 8868

Email: cs03@semiware.com

By QR Code





Website

Machai

To find your local partner within Semiware's global website: www.semiware.com $\ \ \, \mathbb{O} \$ 2022 Semiware Semiconductor Inc.

The content of this document has been carefully checked and understood. However, neither Semiware nor its subsidiaries assume any liability whatsoever for any errors or inaccuracies of this document and the consequences thereof. Published specifications are subject to change without notice. Product suitability for any area of application must ultimately be determined by the customer. In all cases, products must never be operated outside their published specifications. Semiware does not guarantee the availability of all published products. This disclaimer shall be governed by substantive Chinese law and resulting disputes shall be settled by the courts at the place of business of Semiware. Latest publications and a complete disclaimer can be downloaded from the Semiware website. All trademarks recognized.